

UT108N03

Power MOSFET

30V, 108A N-CHANNEL
POWER MOSFET

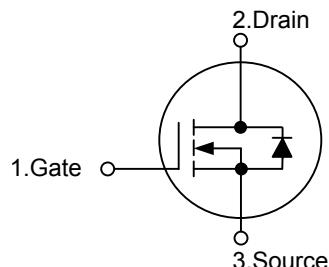
■ DESCRIPTION

As advanced N-channel level power MOSFET, the **UT108N03** is produced using UTC's advanced trench technology, which has been specially tailored to minimize the on-resistance and maintain low gate charge for superior switching performance.

■ FEATURES

- * $R_{DS(ON)} < 5.3\text{m}\Omega$ @ $V_{GS} = 10\text{ V}$, $I_D = 25\text{ A}$
- * Low Capacitance
- * Optimized Gate Charge
- * Fast Switching Capability
- * Avalanche Energy Specified

■ SYMBOL



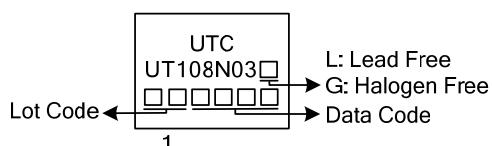
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UT108N03L-TA3-T	UT108N03G-TA3-T	TO-220	G	D	S	Tube
UT108N03L-TM3-T	UT108N03G-TM3-T	TO-251	G	D	S	Tube
UT108N03L-TN3-R	UT108N03G-TN3-R	TO-252	G	D	S	Tape Reel
UT108N03L-TND-R	UT108N03G-TND-R	TO-252D	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

UT108N03L-TA3-T	(1) R: Tape Reel, T: Tube (2) TA3: TO-220, TM3: TO-251, TN3: TO-252 TND: TO-252D (3) L: Lead Free, G: Halogen Free and Lead Free
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	30	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	I_D	108	A
Pulsed Drain Current (Note 2)	I_{DM}	432	A
Avalanche Energy (Note 3)	E_{AS}	580	mJ
Power Dissipation	TO-220	P_D	W
	TO-251/TO-252		
	TO-252D		
Junction Temperature	T_J	+150	$^\circ\text{C}$
Strong Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. $t_P \leq 10\mu\text{s}$, pulsed, $T_A=25^\circ\text{C}$

3. $V_{GS}=10\text{V}$, $T_J=25^\circ\text{C}$, $I_D=35\text{A}$, $V_S \leq 25\text{V}$, $t_P=0.25\text{ms}$, $R_{GS}=50\Omega$

■ THERMAL DATA

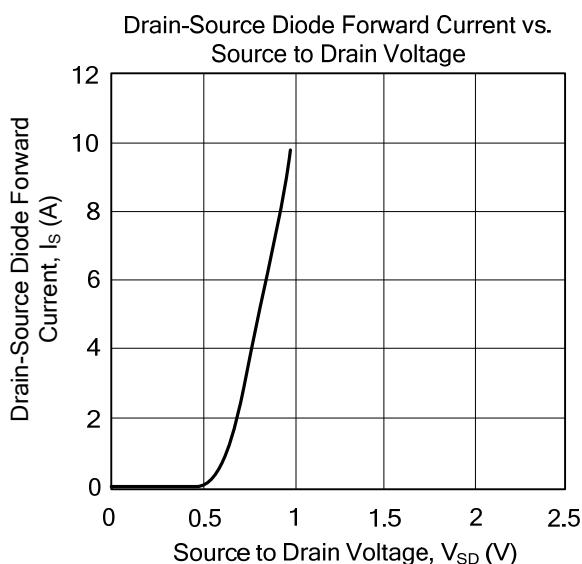
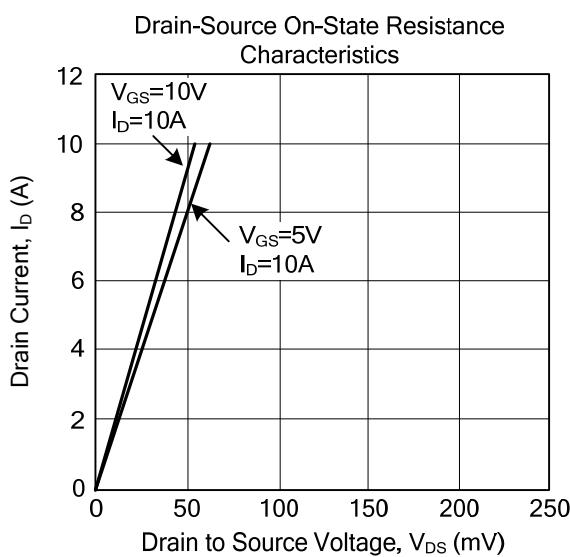
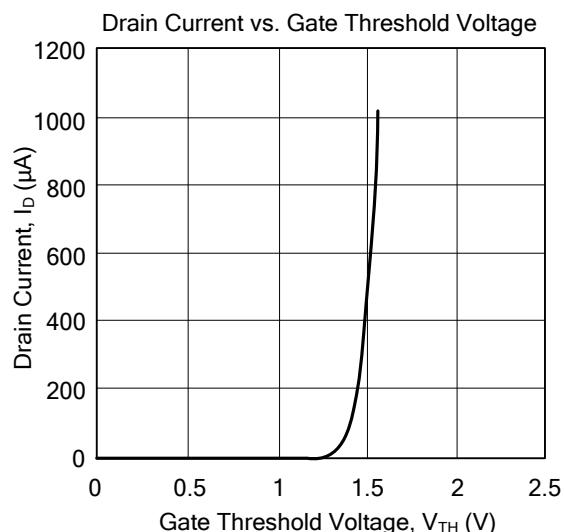
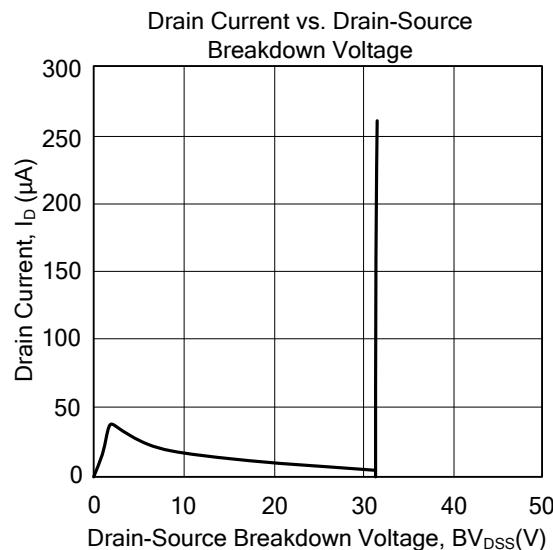
PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220	θ_{JA}	62.5 $^\circ\text{C}/\text{W}$
	TO-251/TO-252		100 $^\circ\text{C}/\text{W}$
	TO-252D		
Junction to Case	TO-220	θ_{JC}	1.4 $^\circ\text{C}/\text{W}$
	TO-251/TO-252		2.5 $^\circ\text{C}/\text{W}$
	TO-252D		

■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	30			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$		0.05	1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=\pm 20\text{V}$		0.02	100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=1\text{mA}$	1		3	V
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=25\text{A}$		4.2	5.3	$\text{m}\Omega$
		$V_{\text{GS}}=5\text{V}, I_{\text{D}}=25\text{A}$			6.6	$\text{m}\Omega$
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		2900		pF
Output Capacitance	C_{OSS}			500		pF
Reverse Transfer Capacitance	C_{RSS}			350		pF
SWITCHING PARAMETERS						
Turn-ON Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DD}}=15\text{V}, R_{\text{G}}=10\Omega, V_{\text{GS}}=5\text{V}, R_{\text{D}}=0.6\Omega, I_{\text{D}}=1\text{A}$		60		ns
Turn-ON Rise Time	t_{R}			100		ns
Turn-OFF Delay Time	$t_{\text{D(OFF)}}$			650		ns
Turn-OFF Fall-Time	t_{F}			300		ns
Total Gate Charge	Q_{G}	$V_{\text{DD}}=15\text{V}, V_{\text{GS}}=5\text{V}, I_{\text{D}}=40\text{A}$		310		nC
Gate Source Charge	Q_{GS}			50		nC
Gate Drain Charge	Q_{GD}			90		nC
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Drain-Source Diode Forward Voltage	V_{SD}	$I_{\text{S}}=108\text{A}, V_{\text{GS}}=0\text{V}$			1.25	V
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}	(Note)			432	A
Body Diode Reverse Recovery Time	t_{rr}	$I_{\text{S}}=20\text{A}, dI_{\text{S}}/dt=-100\text{A}/\mu\text{s}, V_{\text{GS}}=0\text{V}$		34		ns
Body Diode Reverse Recovery Charge	Q_{RR}			27		nC

Note: $t_p \leq 10\mu\text{s}$, pulsed

■ TYPICAL CHARACTERISTICS



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